

## **Ultra Fast Sinterglass Diode**

#### **Features**

- · High temperature metallurgically bonded construction
- · Cavity-free glass passivated junction
- · Superfast recovery time for high efficiency
- · Low forward voltage, high current capability
- · Hermetically sealed package
- · Low leakage current
- · High surge current capability



#### **Mechanical Data**

Case: DO-204AP Sintered glass case Terminals: Plated axial leads, solderable per

MIL-STD-750, Method 2026

Polarity: Color band denotes cathode end

Mounting Position: Any Weight: approx. 560 mg

#### **Parts Table**

Part	Type differentiation	Package	
FE2A	V <sub>RRM</sub> = 50 V	DO-204AP(G-1)	
FE2B	V <sub>RRM</sub> = 100 V	DO-204AP(G-1)	
FE2C	V <sub>RRM</sub> = 150 V	DO-204AP(G-1)	
FE2D	V <sub>RRM</sub> = 200 V	DO-204AP(G-1)	

## **Absolute Maximum Ratings**

 $T_{amb}$  = 25 °C, unless otherwise specified

Parameter	Test condition	Part	Symbol	Value	Unit
Reverse voltage = Repetitive peak reverse voltage	see electrical characteristics	FE2A	$V_R = V_{RRM}$	50	V
		FE2B	$V_R = V_{RRM}$	100	V
		FE2C	$V_R = V_{RRM}$	150	V
		FE2D	$V_R = V_{RRM}$	200	V
Maximum average forward rectified current	0.375 " (9.5 mm) lead length at $T_{amb}$ = 75 °C		I <sub>F(AV)</sub>	2.0	Α
Peak forward surge current	8.3 ms single half sine-wave superimposed on rated load (JEDEC Method)		I <sub>FSM</sub>	50	А
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>STG</sub>	- 55 to + 175	°C



#### **Maximum Thermal Resistance**

T<sub>amb</sub> = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Typical thermal resistance 1), 2)		$R_{ heta JA}$	60	K/W
		$R_{ hetaJL}$	20	K/W

 $<sup>^{1)}</sup>$  Thermal resistance from junction to ambient and/or lead, 0.375 " (9.5 mm) lead length mounted on P.C.B. with 0.5 x 0.5 (12 x 12 mm) copper pads.

#### **Electrical Characteristics**

 $T_{amb}$  = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Min	Тур.	Max	Unit
Maximum instantaneous forward voltage	I <sub>F</sub> = 2.0 A	V <sub>F</sub>			0.95	V
Maximum reverse current	V <sub>R</sub> = V <sub>RRM</sub> , T <sub>amb</sub> = 25 °C	I <sub>R</sub>			2.0	μА
	V <sub>R</sub> = V <sub>RRM</sub> , T <sub>amb</sub> = 100 °C	I <sub>R</sub>			50	μА
Maximum reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$	t <sub>rr</sub>			35	ns
Typical junction capacitance	V <sub>R</sub> = 4 V, f = 1 MHz	C <sub>j</sub>		45		pF

## **Typical Characteristics** ( $T_{amb} = 25$ °C unless otherwise specified)

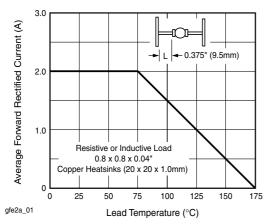


Figure 1. Maximum Forward Current Derating Curve

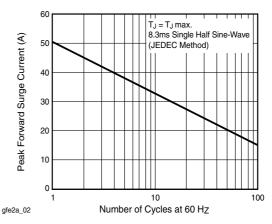


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

<sup>&</sup>lt;sup>2)</sup> Thermal resistance from junction to lead at 0.375 " (9.5 mm) lead length with both leads attached to heatsinks



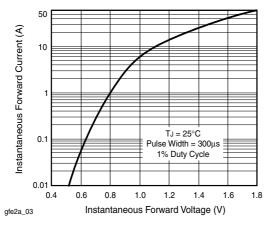


Figure 3. Typical Instantaneous Forward Characteristics

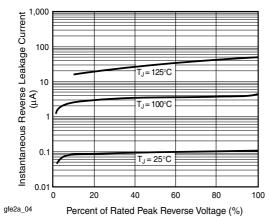


Figure 4. Typical Reverse Leakage Characteristics

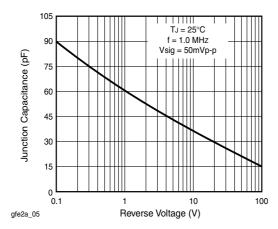
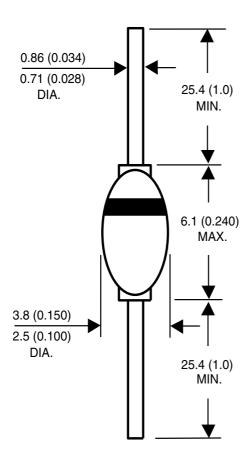


Figure 5. Typical Junction Capacitance

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## **Package Dimensions in mm (Inches)**



17030



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- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

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